

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUSEN YANG	11/19/2018
HUI CHEN	11/19/2018
HUA CUI	11/19/2018
BO XU	11/19/2018
ZHI TAN	11/19/2018
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16208588
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ATTORNEY DOCKET NUMBER:	181014-FSU-HEPU
NAME OF SUBMITTER:	YUE (ROBERT) XU
SIGNATURE:	/YUE XU h/
DATE SIGNED:	12/05/2018
Total Attachments: 2	

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COMBINED ASSIGNMENT AND DECLARATION

WHEREAS, Yusen Yang, Hui Chen, Hua Cui, Bo Xu, and Zhi Tan, hereinafter referred to as "Assignors," are the inventors of the invention described and set forth in the below-identified application for the United States Patent:

Title of Invention: SYNTHETIC AMMONIA SYSTEM FOR MAKING HYDROGEN BY ELECTROLYSIS IN THERMAL POWER PLANT

Attorney docket number: 181014-FSU-HEPU

Application No.: 16208588

Filing date: 04-DEC-2018

WTHEREAS, HEPU Technology Development (Beijing) Co., LTD., located at Building 12, Yard Number 18, Kechuang 13th Street, Beijing Economic and Technology Development Area, Beijing 100176, China, hereinafter referred to as "Assignee," is desirous of acquiring an interest in the invention and application and any U.S. Patent and Registration that may be granted on the same;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have assigned, and by these present do assign to Assignee all right, title and interest in and to the aforesaid invention and application, and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Patents and Registrations that may hereafter be granted on any patent application claiming priority from the same in the same in the United States and all countries throughout the world, and which claim the priority from the application as provided by the Paris Convention. The right, title, and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignors had this Assignment not been made, for the full term of any Patent and Registration that may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation, or extension thereof.

Assignors further agree that they will, without charge to Assignor, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent Applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Patent and Registrations for the invention and

improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignors hereby authorize and request U.S. FairSky LLP to insert herein above the application serial number and filing date of said application when known.

THE ABOVE-IDENTIFIED APPLICATION WAS MADE OR AUTHORIZED TO BE MADE BY ME. I BELIEVE THAT I AM THE ORIGINAL INVENTOR OR AN ORIGINAL JOINT INVENTOR OF A CLAIMED INVENTION IN THE APPLICATION. I HEREBY ACKNOWLEDGE THAT ANY WILLFUL FALSE STATEMENT MADE IN THIS DECLARATION IS PUNISHABLE UNDER 18 U.S.C. 1001 BY FINE OR IMPRISONMENT OF NOT MORE THAN FIVE (5) YEARS, OR BOTH.

IN TESTIMONY WHEREOF, the Assignors (and each of them, if more than one) have signed below.

Inventor one: <u>Yusen Yang</u>	Date: <u>2018/11/19</u>
Signature: <u>Yusen Yang</u>	
Inventor two: <u>Hui Chen</u>	Date: <u>2018/11/19</u>
Signature: <u>Hui Chen</u>	
Inventor three: <u>Hua Cui</u>	Date: <u>2018/11/19</u>
Signature: <u>Hua Cui</u>	
Inventor four: <u>Bo Xu</u>	Date: <u>2018/11/19</u>
Signature: <u>Bo Xu</u>	
Inventor four: <u>Zhi Tan</u>	Date: _____
Signature: <u>Zhi Tan</u>	<u>2018/11/19</u>